

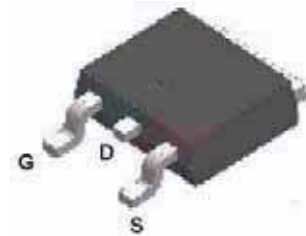
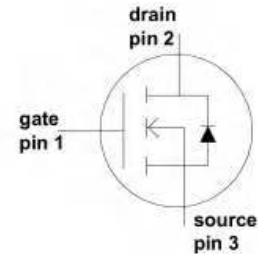
**Super-junction Power Mosfet**

**Features**

- 650V,31A  
 $R_{DS(ON)} < 100m\Omega @ V_{GS}=10V$  TYP: 90m $\Omega$
- Super junction technology
- Extremely low on resistance

**Applications**

- LED/LCD/PDP TV and monitor Lighting
- Solar/Renewable/UPS-Micro Inverter System
- Charger
- Power Supply
- Halogen-free



TO-263 top view

**Package Marking and Ordering Information**

Device Marking	Device	Package	Packaging Code	Reel Size	Quantity(Pcs)	Carton(Pcs)
31N650	RM31N650HD	TO-263	-W	13inch	800	6400

**ABSOLUTE MAXIMUM RATINGS ( $T_J=25^{\circ}C$  unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	650	V
Gate-Source Voltage	$V_{GS}$	$\pm 30$	V
Continuous Drain Current ( $T_c = 25^{\circ}C$ )	$I_D$	31	A
Continuous Drain Current ( $T_c = 100^{\circ}C$ )	$I_D$	20	A
Pulsed Drain Current <sup>(1)</sup>	$I_{DM}$	93	A
Single Pulsed Avalanche Energy <sup>(2)</sup>	$E_{AS}$	480	mJ
Drain Power Dissipation	$P_D$	321	W
Thermal Resistance from Junction to Case	$R_{\theta JC}$	0.39	$^{\circ}C/W$
Thermal Resistance- Junction to Ambient	$R_{\theta JA}$	62	$^{\circ}C/W$
Junction Temperature	$T_J$	150	$^{\circ}C$
Storage Temperature	$T_{STG}$	-55~ +150	$^{\circ}C$

## MOSFET ELECTRICAL CHARACTERISTICS( $T_J=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	650	-	-	V
		$V_{GS} = 0V, I_D = 250\mu A, T_J = 150^{\circ}\text{C}$	700			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 650V, V_{GS} = 0V$	-	-	5	$\mu A$
		$V_{DS} = 650V, V_{GS} = 0V, T_J = 150^{\circ}\text{C}$			800	$\mu A$
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 30V, V_{DS} = 0V$	-	-	$\pm 100$	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	3.0	-	5.0	V
Forward Transconductance	$g_{FS}$	$V_{DS} = 20V, I_D = 17A$	-	19.0	-	S
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 17A$	-	90	99	m $\Omega$
<b>Dynamic characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 100V, V_{GS} = 0V, f = 1.0\text{MHz}$	-	1900	-	pF
Output Capacitance	$C_{oss}$		-	118	-	
Reverse Transfer Capacitance	$C_{rss}$		-	2.2	-	
Gate Resistance	$R_g$	$f = 1.0\text{MHz}$		0.9		$\Omega$
<b>Switching characteristics</b>						
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 400V, I_D = 17A, R_G = 27\Omega, V_{GS} = 10V$	-	50	-	ns
Turn-on rise time	$t_r$		-	80	-	
Turn-off delay time	$t_{d(off)}$		-	180	-	
Turn-off fall time	$t_f$		-	50	-	
Total Gate Charge	$Q_g$	$V_{DS} = 480V, I_D = 17A, V_{GS} = 10V$	-	70	-	nC
Gate-Source Charge	$Q_{gs}$		-	17.0	-	
Gate-Drain Charge	$Q_{gd}$		-	45	-	
<b>Source-Drain Diode characteristics</b>						
Diode Forward voltage	$V_{SD}$	$T_c = 25^{\circ}\text{C}, V_{GS} = 0V, I_S = 17A$	-	0.9	1.1	V
Diode Forward current	$I_S$	$T_c = 25^{\circ}\text{C}$	-	-	31	A
Body Diode Reverse Recovery Time	$t_{rr}$	$T_c = 25^{\circ}\text{C}, I_F = 17A, di/dt = 100A/\mu s$		140		ns
Body Diode Reverse Recovery Charge	$Q_{rr}$	$T_c = 25^{\circ}\text{C}, I_F = 17A, di/dt = 100A/\mu s$		0.89		$\mu c$

### Notes:

1. Pulse width limited by maximum junction temperature
2.  $L=60\text{mH}, I_{AS}=4A, V_G=10V, R_G=30\Omega$ , starting  $T_J=25^{\circ}\text{C}$
3. Pulse Test: Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$
4. Essentially independent of operating temperature

# RATING AND CHARACTERISTICS CURVES (RM31N650HD)

Figure1. Safe operating area

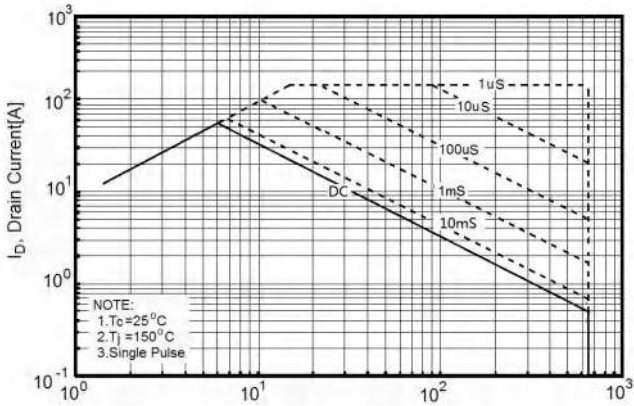


Figure2. Capacitance

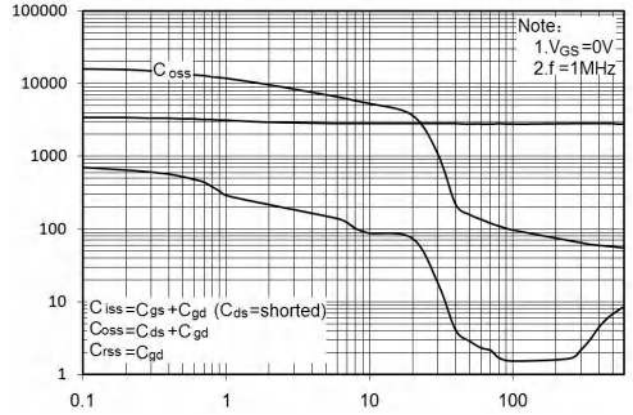


Figure3. Source-Drain Diode Forward Voltage

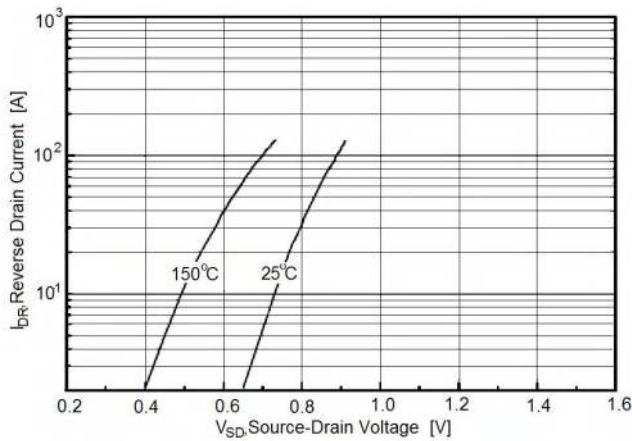


Figure4. Output characteristics

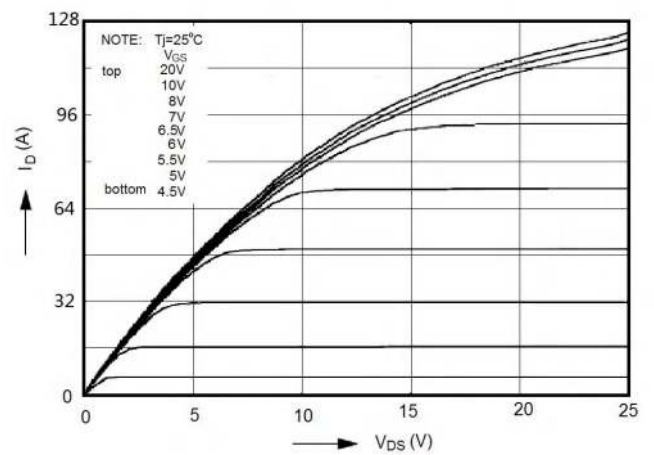


Figure5. Transfer characteristics

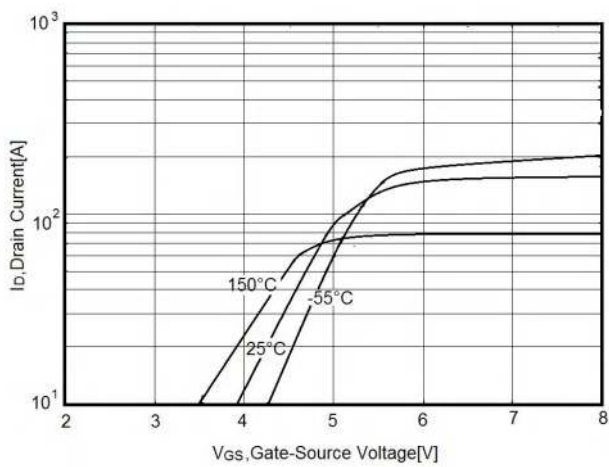
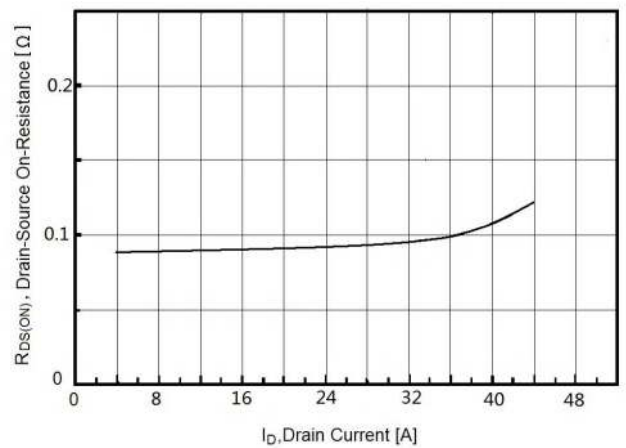


Figure6. Static drain-source on resistance



# RATING AND CHARACTERISTICS CURVES (RM31N650HD)

Figure7.  $R_{DS(ON)}$  vs Junction Temperature

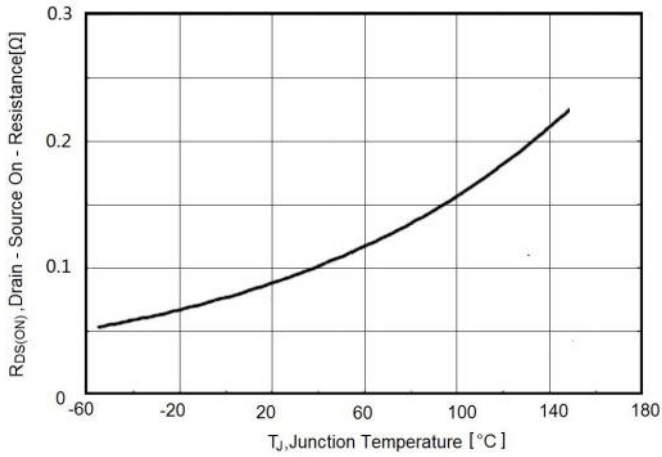


Figure8.  $BV_{DSS}$  vs Junction Temperature

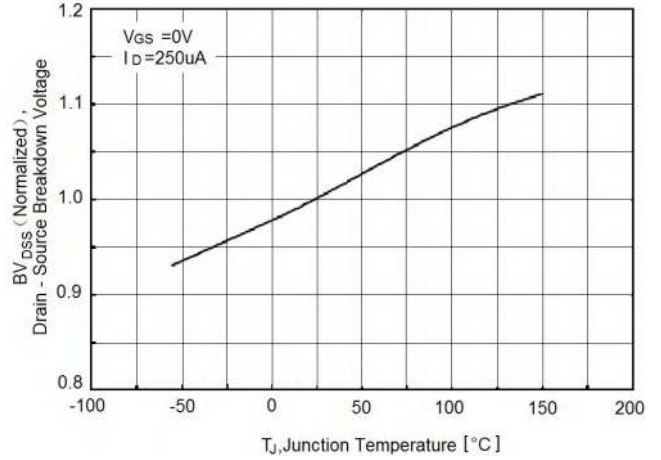


Figure9. Maximum  $I_D$  vs Junction Temperature

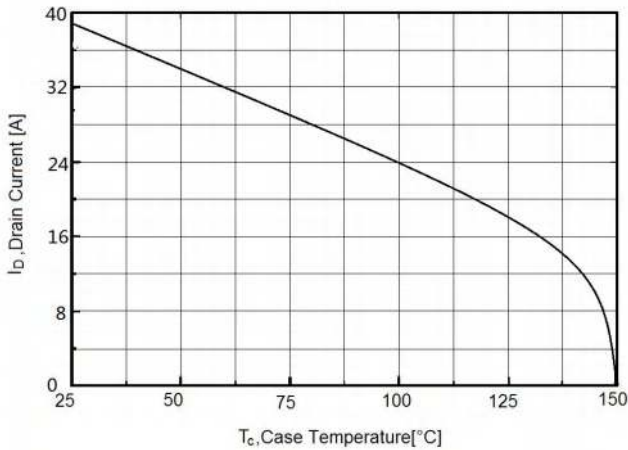
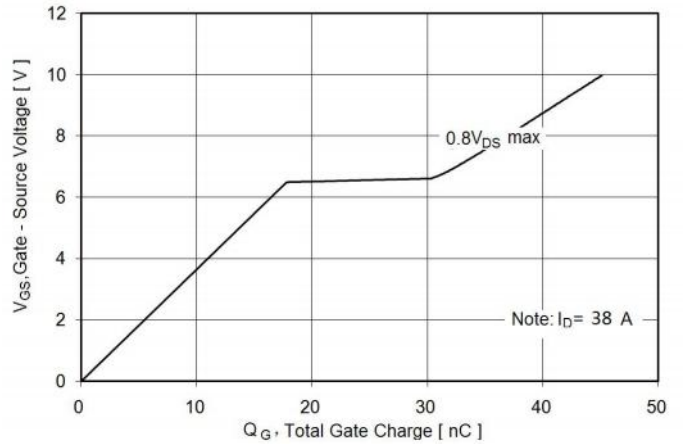
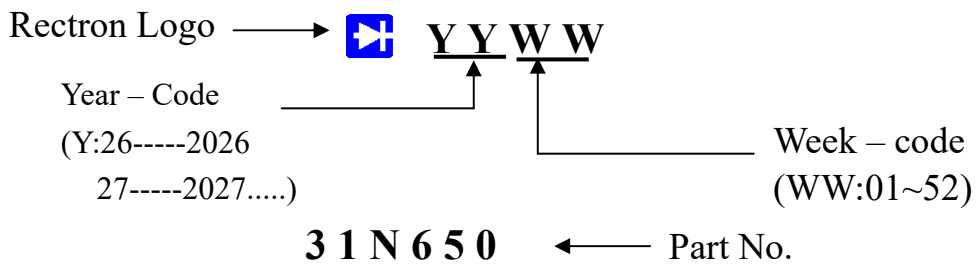


Figure10. Gate charge waveforms

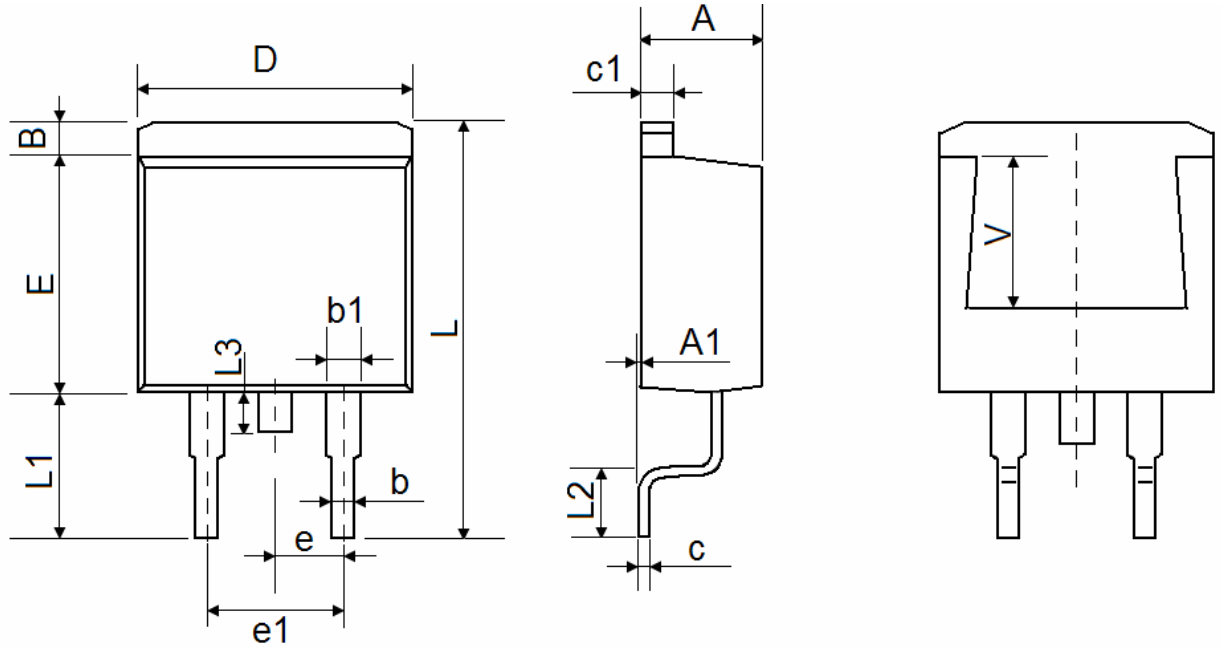


# RECTRON

## Marking on the body



## TO-263 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.470	4.670	0.176	0.184
A1	0.000	0.150	0.000	0.006
B	1.170	1.370	0.046	0.054
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.310	0.530	0.012	0.021
c1	1.170	1.370	0.046	0.054
D	10.010	10.310	0.394	0.406
E	8.500	8.900	0.335	0.350
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
L	15.050	15.450	0.593	0.608
L1	5.080	5.480	0.200	0.216
L2	2.340	2.740	0.092	0.108
L3	1.300	1.700	0.051	0.067
V	5.600 REF		0.220 REF	

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